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# TACT Switch

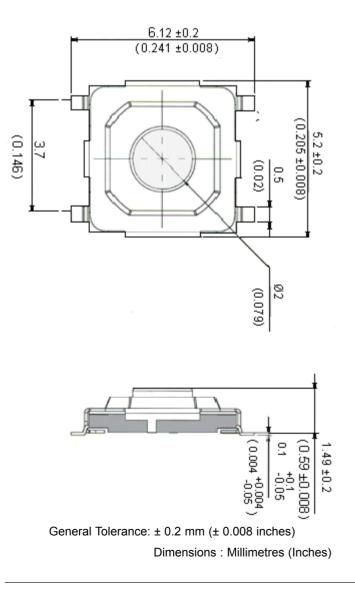




### Features

- Sharp click feel with a positive tactile feed-back. Due to small movement distance (stroke), user experiences distinct sensation when the switch clicks into place
- Ultraminiature and light weight structure suitable for high density mounting. Economic but high reliability
- Insert moulding in the contact with special treatment prevents flux build-up during soldering and permits auto-dipping



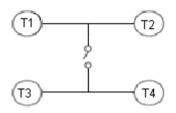




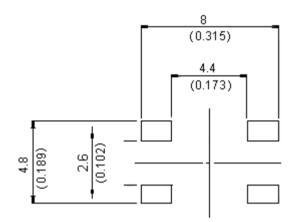


# **TACT** Switch

## **Circuit Diagram**



## **PCB** Layout



# Materials

Cover	: Stainless steel
Contact Disc	: Phosphor bronze with silver cladding
Terminal	: Brass with silver cladding
Base	: LCP High-temperature thermoplastic
	Colour : Black
Stem	: Brass

# **Specifications**

#### Mechanical

Operation Force Stop Strength

Stroke Operating Temperature Range Storage Temperature Range Vibration Test

#### : 160 ±50 gf

Time

: Place the switch such that vertical, a static load of 3 kgf shall be applied in the direction of stem operation for a period of 15 seconds

- : 0.25 (+0.2 mm / -0.1 mm)
- : -25°C to +70°C
- : -30°C to +80°C

: MIL-STD-202F Method 201 A

- Frequency : 10 55 10 Hz/1 minute
- Directions : X, Y, Z, three mutually perpendicular directions
  - : 2 hours each direction

High reliability





# TM-533-T/R

**TACT Switch** 

# Spe

Specifications	
Mechanical Shock Test	: MIL-STD-202F Method 213B Condition A Gravity : 50 G (peak value), 11 milliseconds Direction and times : 6 sides and 3 times in each direction High reliability
<b>Electrical</b> Electrical Life Contact Resistance Insulation Resistance Dielectric Strength Contact Arrangement	: 300,000 cycles minimum : 100 mΩ maximum : 100 mΩ minimum at 500 V dc : 250 V ac/1 minute : 1 Pole 1 throw
Soldering Process Wave Soldering Hand Soldering Soldering Condition for Soldering (	<ul> <li>: Recommended solder temperature at 500°F (260°C) maximum 5 seconds subject to PCB 1.6 mm thickness. (Soldering for through hole type)</li> <li>: Use a soldering iron of 30 watts, controlled at 608°F (320°C) approximately 2 seconds while applying solder</li> <li>: Vapour phase and IR-reflow soldering can be applied Reflow and non-washable type)</li> </ul>
Maxin <b>Temperature Profile:</b> Room Tem	num 240 180 perature 30 - 40 80 - 90 10 - 15 Time (S)

## **Part Number Table**

Description	Part Number	
TACTILE SWITCH, SPNO, SMD	TM-533I-Q-T/R	

ltem	Description	Materials	Treatment	Remarks
1	Stem	SPCC-SD	Ni Plating	-
2	Cover	□ = Nickel Silver S = Stainless Steel	□ = None S = With Silver Plating	-
3	Adhesive Tape	Teflon	None	-
4	Terminal	Phosphor Bronze	With Silver Plating	-
5	Contact	Stainless Steel	With Silver Cladding	-
6	Base	High – Temperature Thermoplastic LCP	Moulded Black	-

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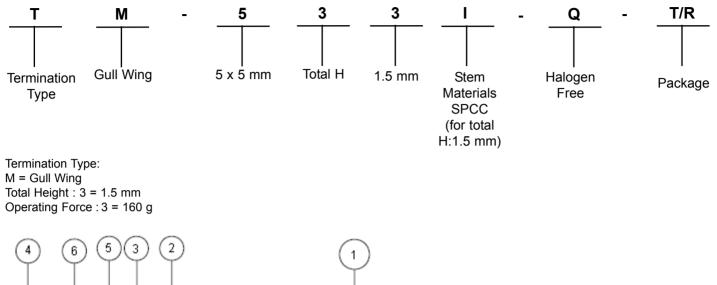
multicomp

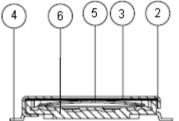


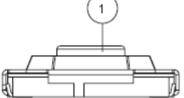
# **TACT** Switch

# multicomp

Part Number Explanation:







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